



**IDS - 01/22/2014 ELECTRONIC INFORMATION DISCLOSURE STATEMENT**

Electronic Version v18

Stylesheet Version v18.0

<b>Title of Invention</b>	<b>INTEGRATION OF HIGH PERFORMANCE COPPER INDUCTORS WITH BOND PADS</b>						
<p>Application Number :</p> <p>Confirmation Number:</p> <p>First Named Applicant: Jeffrey Gambino</p> <p>Attorney Docket Number: BUR920030071US1</p> <p>Art Unit:</p> <p>Examiner:</p> <p>Search string: ( 5478773 or 5695810 or 6153935 or 6259160 or 20020197844 ).pn</p>							
<b>US Patent Documents</b>							
<b>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</b>							
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
ADT	1	5478773	1995-12-26	Dow et al		-	-
	2	5695810	1997-12-09	Dubin et al		-	-
	3	6153935	2000-11-28	Edelstein et al		-	-
ADT	4	6259160	2001-07-10	Lopatin et al		-	-
<b>US Published Applications</b>							
<b>Note: Applicant is not required to submit a paper copy of cited US Published Applications</b>							
init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
ADT	1	20020197844	2002-12-26	Johnson, et al		-	-
<b>Signature</b>							
Examiner Name				Date			
/A. Dexter Tugbang/				7/20/06			